

Lonten N-channel 40V, 20A, 12mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- $40V,20A,R_{DS(ON).max}=12m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- ◆ Fast switching
- Green device available

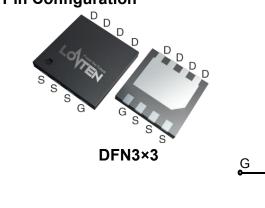
Applications

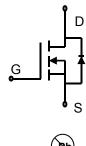
- Motor Drives
- ◆ UPS
- DC-DC Converter

Product Summary

 $\begin{array}{ll} V_{DSS} & \quad \ \, 40V \\ R_{DS(on).max} @ \ V_{GS} \text{=} 10V & \quad \, 12m\Omega \\ I_D & \quad \, 20A \end{array}$

Pin Configuration





N-Channel MOSFET

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	40	V
Continuous drain current (T _C = 25°C)		20	A
Continuous drain current (T _C = 100°C)	l _D	12.5	A
Pulsed drain current ¹⁾	I _{DM}	80	A
Gate-Source voltage	Vess		V
Power Dissipation (T _C = 25°C)	P _D	20	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit			
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	6.25	°C/W			



Package Marking and Ordering Information

Device	Device Package	Marking
LNND04R120	DFN3×3	04R120

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	-					
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	40			V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		2.0	V
5	I _{DSS}	V _{DS} =40 V, V _{GS} =0 V, T _J = 25°C			1	μA
Drain-source leakage current		V _{DS} =32 V, V _{GS} =0 V, T _J = 125°C			10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA
Dunin course on state assistance	В	V _{GS} =10 V, I _D =12 A		7.5	12	mΩ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =8 A		9.5	16	mΩ
Forward transconductance	g fs	V _{DS} =5 V , I _D =20A		35		S
Dynamic characteristics						
Input capacitance	C _{iss}	\/ - 20\/ \/ - 0\/		1370		
Output capacitance	Coss	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V},$ $V_{DS} = 1 \text{ MHz}$		149		pF
Reverse transfer capacitance	Crss	- F = 1WIDZ		115		
Turn-on delay time	t _{d(on)}			4.8		
Rise time	t _r	$V_{DD} = 20V, V_{GS} = 10V, I_{D} = 10 A$		19.2		ns
Turn-off delay time	t _{d(off)}	VDD - 20V,VGS-10V, ID - 10 A		73		
Fall time	t _f			21		
Gate resistance	Rg	V _{GS} =0V, V _{DS} =0V, F=1MHz		3.5		Ω
Gate charge characteristics						
Gate to source charge	Q _{gs}	V 00V I 101		6		
Gate to drain charge	Q _{gd}	V _{DS} =20V, I _D =10A,		3.8		nC
Gate charge total	Qg	- V _{GS} = 10V		25		
Drain-Source diode characteristics and Maximum Ratings						
Continuous Source Current	Is				20	Α
Pulsed Source Current ³⁾	I _{SM}				80	Α
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =10A, T _J =25℃			1.2	V
Reverse Recovery Time	t _{rr}	1 -404 di/dt-4004/ T 05%		34		ns
Reverse Recovery Charge	Qrr	I _S =10A,di/dt=100A/us, T _J =25℃		10.2		nC

Notes:

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^{1:} Repetitive Rating: Pulse width limited by maximum junction temperature.

^{2:} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.



Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

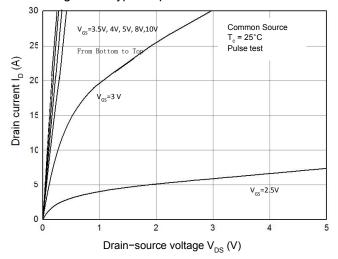


Figure 2. Transfer Characteristics

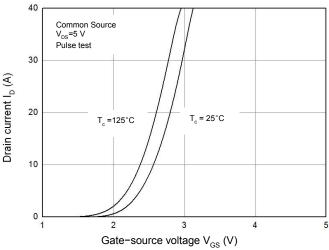


Figure 3. Capacitance Characteristics

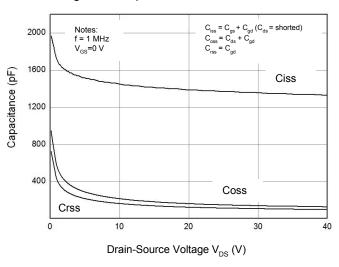


Figure 4. Gate Charge Waveform

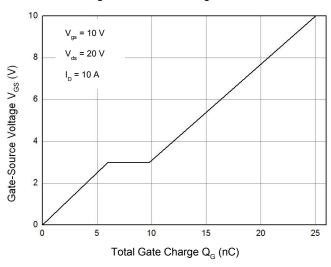


Figure 5. Body-Diode Characteristics

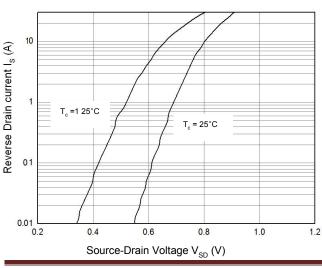
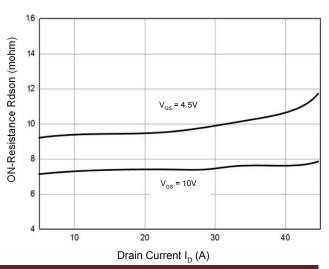


Figure 6. Rdson-Drain Current





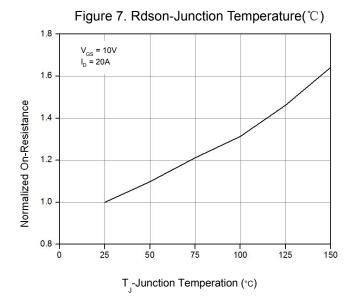
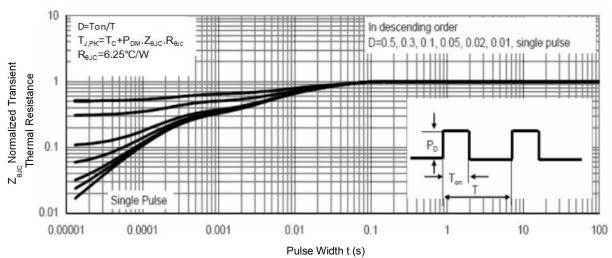


Figure 9. Normalized Maximum Transient Thermal Impedance (RthJC)

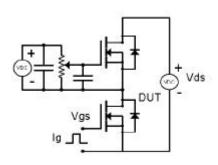


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Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



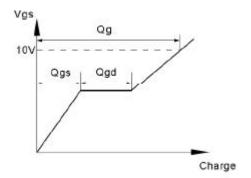
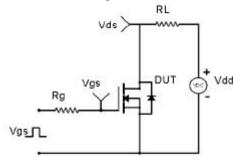


Figure 9. Resistive Switching Test Circuit & Waveforms



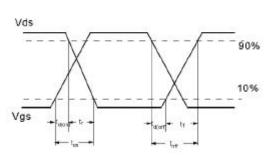
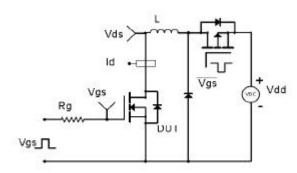


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



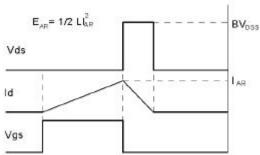
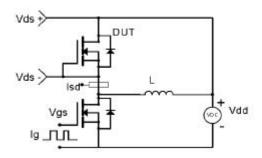
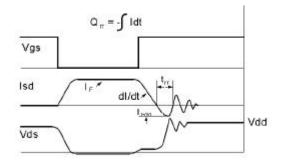


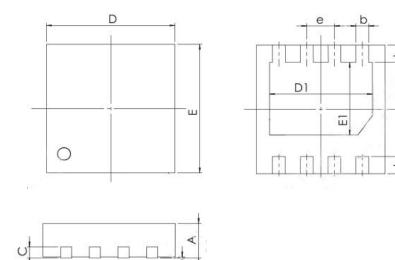
Figure 11. Diode Recovery Circuit & Waveform





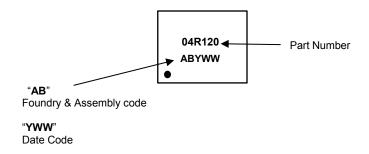


Mechanical Dimensions for DFN3imes3



SYMBOL		MILLIMETERS	S
	MIN	NOM	MAX
Α	0.70	0.75	0.80
A1	NA	0.02	0.05
b	0.25	0.30	0.35
С	0.18	0.20	0.30
D	2.95	3.00	3.07
E	2.95	3.00	3.07
D1	2.30	2.40	2.50
E1	1.60	1.70	1.80
L	0.30	0.40	0.50
е	0.65BSC		

DFN3×3 Part Marking Information





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